Sang Kim

Education

New York University

New York, NY

B.S. MECHANICAL ENGINEERING, GPA: 3.27/4.0, DEAN'S LIST (2018-2020)

Aug 2016 - May 2020

• Organizations: Othmer Hall Council, American Society of Mechanical Engineers, Society of Asian Scientists and Engineers

Experience

WOOMBA (Dr. Morris Young Outstanding Project Design Award Recipient)

New York, NY

DESIGN ENGINEER

Aug 2019 - May 2020

- Designed the framework and mechanical components of a payload carrying electric powered aquatic vehicle tasked with removing surface pollution with the use of SolidWorks
- Reduced empty weight of frame through static structural analysis by over 25% using ANSYS Workbench & SolidWorks Simulations
- · Optimized framework design to improve dynamic stability by 70% and surface area for interfaces/attachments by over 100%
- Developed 2D drawings of parts and assemblies with Bill of Materials to document purchased and manufactured parts

MakerBot Industries

New York, NY

MATERIALS AND TEST ENGINEERING INTERN

Sep 2019 - Dec 2019

- Integrated LabVIEW program with testing apparatus comprised of PID, force gauges, encoders, & data acquisition box to automate material testing
- Processed and analyzed material testing data for over 20 unique 3D printing spools with the use of R Studio and Microsoft Excel, which would be used in understanding material behavior during print tuning
- Performed print tuning for Tough PLA using analyzed testing data to develop optimal printing settings for dimensional accuracy, print quality, and extrusion performance consistency

NYU Dibner IT (Division of Libraries Dean's Award)

New York, NY

SPECIALIZED DESIGN LEAD

Nov 2018 - Apr 2020

- · Lead the design and implementation of technological enhancements to the library with innovative solutions
- · Designed & installed housing units for Ultrasonic sensors utilized in human detection to predict occupancy of over 500 seats
- Increased manufacturing volume of housing units by 50% by performing design analyses in CatalystEX & Netfabb
- Implemented unique security mechanisms in Raspberry Pi cases to prevent tampering/theft of over \$1000 of hardware
- · Designed 3D printed parts for an 'Apollo Mission' display powered by stepper motors and Arduino using SolidWorks

NYU Aerospace - SAE Aero Advanced Class

New York, NY

MECHANICAL DESIGN ENGINEER AND MANUFACTURING LEAD

Oct 2018 - Apr 2019

- Redesigned wing box and payload carrying fuselage after failed test flight to increase structural strength while reducing weight by 30% using SolidWorks Simulations
- Reduced stress concentration on center wing box by 60% through static structural analysis using SolidWorks Simulations
- Designed removable carbon fiber boom twin-tail of primary aircraft for easier manufacturing and improved control during flight
- Decreased rear landing gear weight by over 50% using ANSYS Workbench & machine design calculations, improving static stability

Additional Projects

• The Apollo Project, Advanced CAD: R2D2, BDI/AEM Manufacturing Analysis of Pepper Mill, RePrint Bot, 3D Printed Robotic Crane Arm

Skills

Software SolidWorks, AutoCAD, CATIA v5, KeyShot8, ANSYS Workbench

Processes DFA/DFM, Design Conceptualization, Design Calculation, Iterative Designing/Continuous Improvement

GD&T, Injection Molding, Blow Molding, Waterjet Cutting, Laser Cutting, CNC Machining

3D Printing, Rapid Prototyping, Hardware/Product Testing, Root Cause Analysis

Languages RStudio, MATLAB, Python, LabVIEW, HTML/CSS, JavaScipt, Bootstrap

Misc. Tech. Mac, Windows, BASH, Git, Adobe Creative Suite, Microsoft Office, Raspberry Pi, Arduino